















**ESD** 

TVS

MOS

LDO

Diode

Sensor

DC-DC

# **Product Specification**

Domestic Part Number	74HC273D
<ul><li>Overseas Part Number</li></ul>	74HC273D
▶ Equivalent Part Number	74HC273D





## Octal D Flip-Flop withCommon Clock and Reset

## Description

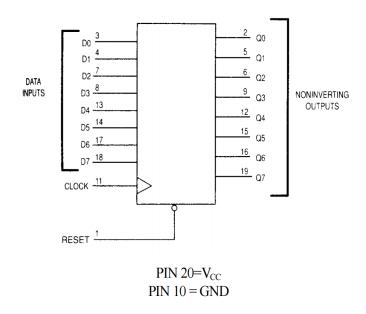
The 74HC273D is identical in pinout to the LS/ALS273. The device inputs are compatible with standard CMOS outputs; with pullup resistors, they are compatible with LS/ALSTTL outputs.

#### **Features**

- Outputs Directly Interface to CMOS, NMOS, and TTL
- Operating Voltage Range: 2.0 to 6.0 V
- Low Input Current: 1.0 μA
- High Noise Immunity Characteristic of CMOS Devices

This device consists of eight D flip-flops with common Clock and Reset inputs. Each flip-flop is loaded with a low-to-high transition of the Clock input. Reset is asynchronous and active low.

#### **LOGIC DIAGRAM**



### **FUNCTION TABLE**

Inputs			Output
Reset	Clock	D	Q
L	X	X	L
Н	\	Н	Н
Н	\	L	L
Н	L	X	no change
Н	/	X	no change

X = don't care



## MAXIMUM RATINGS\*

Symbol	Parameter	Value	Unit
$V_{CC}$	DC Supply Voltage (Referenced to GND)	-0.5 to +7.0	V
$V_{\rm IN}$	DC Input Voltage (Referenced to GND)	$-1.5$ to $V_{CC} + 1.5$	V
$V_{OUT}$	DC Output Voltage (Referenced to GND)	$-0.5$ to $V_{CC} + 0.5$	V
$I_{IN}$	DC Input Current, per Pin	±20	mA
$I_{OUT}$	DC Output Current, per Pin	±35	mA
$I_{CC}$	DC Supply Current, V <sub>CC</sub> and GND Pins	±75	mA
$P_D$	Power Dissipation in Still Air, Plastic DIP+ SOIC Package+	750 500	mW
Tstg	Storage Temperature	-65 to +150	°C
$T_{\rm L}$	Lead Temperature, 1 mm from Case for 10 Seconds (Plastic DIP or SOIC Package)	260	°C

<sup>\*</sup>Maximum Ratings are those values beyond which damage to the device may occur. Functional operation should be restricted to the Recommended Operating Conditions.

SOIC Package: : - 7 mW/°C from 65° to 125°C

## RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Max	Unit
$V_{CC}$	DC Supply Voltage (Referenced to GND)		6.0	V
$V_{\rm IN}, V_{\rm OUT}$	DC Input Voltage, Output Voltage (Referenced to GND)	0	$V_{CC}$	V
$T_{A}$	Operating Temperature, All Package Types		+125	°C
$t_r, t_f$	Input Rise and Fall Time (Figure 1) $V_{CC} = 2.0 \text{ V}$ $V_{CC} = 4.5 \text{ V}$ $V_{CC} = 6.0 \text{ V}$	0 0 0	1000 500 400	ns

<sup>+</sup>Derating - Plastic DIP: - 10 mW/°C from 65° to 125°C



## DC ELECTRICAL CHARACTERISTICS(Voltages Referenced to GND)

				Guaranteed Limit			
Symbol	Parameter	Test Conditions	V	25 °C to -55°C	≤85 °C	≤125 °C	Unit
$V_{IH}$	Minimum High-Level Input Voltage	$V_{OUT}$ =0.1 V or $V_{CC}$ -0.1 V $ I_{OUT}  \le 20 \mu A$	2.0 4.5 6.0	1.5 3.15 4.2	1.5 3.15 4.2	1.5 3.15 4.2	V
$V_{\rm IL}$	Maximum Low -Level Input Voltage	$V_{OUT}$ =0.1 V or $V_{CC}$ -0.1 V $ I_{OUT}  \le 20 \mu A$	2.0 4.5 6.0	0.5 1.35 1.8	0.5 1.35 1.8	0.5 1.35 1.8	V
$V_{\mathrm{OH}}$	Minimum High-Level Output Voltage	$V_{IN}=V_{IH}$ or $V_{IL}$ $\mid I_{OUT}\mid \leq 20~\mu A$	2.0 4.5 6.0	1.9 4.4 5.9	1.9 4.4 5.9	1.9 4.4 5.9	V
		$V_{IN}=V_{IH}$ or $V_{IL}$ $\mid I_{OUT} \mid \le 4.0 \text{ mA}$ $\mid I_{OUT} \mid \le 5.2 \text{ mA}$	4.5 6.0	3.98 5.48	3.84 5.34	3.7 5.2	
$V_{\mathrm{OL}}$	Maximum Low-Level Output Voltage	$  V_{IN} = V_{IL} \text{ or } V_{IH} $ $  I_{OUT}  \le 20 \mu A $	2.0 4.5 6.0	0.1 0.1 0.1	0.1 0.1 0.1	0.1 0.1 0.1	V
		$V_{IN} = V_{IL} \text{ or } V_{IH}$ $\mid I_{OUT} \mid \le 4.0 \text{ mA}$ $\mid I_{OUT} \mid \le 5.2 \text{ mA}$	4.5 6.0	0.26 0.26	0.33 0.33	0.4 0.4	
$I_{IN}$	Maximum Input Leakage Current	V <sub>IN</sub> =V <sub>CC</sub> or GND	6.0	±0.1	±1.0	±1.0	μА
$I_{CC}$	Maximum Quiescent Supply Current (per Package)	$V_{IN}=V_{CC}$ or GND $I_{OUT}=0\mu A$	6.0	4.0	40	160	μА

## AC ELECTRICAL CHARACTERISTICS(C<sub>L</sub>=50pF,Input t<sub>r</sub>=t<sub>f</sub>=6.0 ns)

		$V_{CC}$	Guaranteed Limit			
Symbol	Parameter	V	25 °C to -55°C	≤85°C	≤125°C	Unit
$f_{max}$	Maximum Clock Frequency (50% Duty Cycle) (Figures 1 and 4)	2.0 4.5 6.0	6.0 30 35	5.0 24 28	4.0 20 24	MHz
$t_{\rm PLH}, t_{\rm PHL}$	Maximum Propagation Delay, Clock to Q (Figures 1 and 4)	2.0 4.5 6.0	145 29 25	180 36 31	220 44 38	ns
t <sub>PHL</sub>	Maximum Propagation Delay , Reset to Q (Figures 2 and 4)	2.0 4.5 6.0	145 29 25	180 36 31	220 44 38	ns
$t_{TLH}, t_{THL}$	Maximum Output Transition Time, Any Output (Figures 1 and 4)	2.0 4.5 6.0	75 15 13	95 19 16	110 22 19	ns
$C_{IN}$	Maximum Input Capacitance	-	10	10	10	pF

	Power Dissipation Capacitance (Per Enabled Output)	Typical @25°C,V <sub>CC</sub> =5.0 V	
$C_{PD}$	Used to determine the no-load dynamic power consumption: $P_D = C_{PD}V_{CC}^2 f + I_{CC}V_{CC}$	48	pF



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